

MB89636RPF-G-1355-BNDE1

MB89636RPF-G-1355-BNDE1 Information



Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



MB89636RPF-G-1355-BNDE1 Specifications

Manufacturer Part Number	MB89636RPF-G-1355-BNDE1
Manufacturer	Cypress Semiconductor Corp
Category	Integrated Circuits (ICs)
	Embedded - Microcontrollers
Package	64-BQFP
Series	F2MC-8L MB89630R
Core Processor	F2MC-8L
Core Size	8-Bit
Speed	10MHz
Connectivity	EBI/EMI, Serial I/O, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	53
Program Memory Size	24KB (24K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	2.2 V ~ 6 V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	-
Package / Case	64-BQFP
Supplier Device Package	64-QFP (14x20)
	Report errors?

MB89636RPF-G-1355-BNDE1 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

MB89636RPF-G-1355-BNDE1 Payment Methods



If you have any question about MB89636RPF-G-1355-BNDE1, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com